

Blade Computing with the AMD Opteron[™] Processor ("Magny-Cours")

Pat Conway (Presenter) Nathan Kalyanasundharam Gregg Donley Kevin Lepak Bill Hughes





Agenda

Processor Architecture

- AMD driving the x86 64-bit processor evolution
- Driving forces behind the Twelve-Core AMD Opteron[™] processor codenamed "Magny-Cours"
- CPU silicon
- MCM 2.0 package, speeds and feeds

Performance and scalability

- 2P/4P blade and rack topologies
- HyperTransport[™] technology HT Assist design
 - Cache coherence protocol
 - Transaction scenarios and frequencies
 - Coverage ratio
 - Memory latency and bandwidth

A look ahead





x86 64-bit Architecture Evolution

	2003	2005	2007	2008	2009	2010	
	AMD Opteron™	AMD Opteron™	"Barcelona"	"Shanghai"	"I stanbul"	"Magny-Cours"	
Mfg. Process	90nm SOI	90nm SOI	65nm SOI	45nm SOI	45nm SOI	45nm SOI	
CPU Core	K8	K8	Greyhound	Greyhound+	Greyhound+	Greyhound+	
L2/ L3	1 MB/ 0	1 MB/0	512kB/2MB	512kB/6MB	512kB/6MB	512kB/12MB	
Hyper Transport™ Technology	3x 1.6GT/.s	3x 1.6GT/.s	3x 2GT/s	3x 4.0GT/s	3x 4.8GT/s	4x 6.4GT/s	
Memory	2x DDR1 300	2x DDR1 400	2x DDR2 667	2x DDR2 800	2x DDR2 1066	4x DDR3 1333	

Max Power Budget Remains Consistent





Dramatic Back-to-back Gains



"Shanghai" to "I stanbul" delivers 34% more performance in the same power envelope

* "Magny-Cours" and Future silicon data is based on AMD projections



Driving Forces Behind "Magny-Cours"

Server Throughput	Exploit thread level parallelismLeverage Directly Connected MCM 2.0
Virtualization	 Maximize compute density in 2P/4P blades and racks Run more VMs per server Provide hardware context (thread) based QOS
Energy Proportional Computing	More performance, same power envelopePower conservation when idle
Economics	 Design efficiency – "Magny-Cours" silicon same as "Istanbul" Can help speed qualification times and customers' time to market Reasonable die size permits 2 die per reticle (Yield ↑ Manufacturing Cost ↓) Yield improvements can help ensure supply chain stability Manufacturing cost savings ultimately benefit customers





"Magny-Cours" Silicon







MCM 2.0 Logical View







Topologies





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(*) XFIRE BW is the maximum available coherent memory bandwidth if the HT links were the only limiting factor. Each node accesses its own memory and that of every other node in an interleaved fashion.



Block Diagram







HyperTransport™ Technology HT Assist (Probe Filter)

Key enabling technology on "Istanbul" and "Magny-Cours"

HT Assist is a sparse directory cache

- Associated with the memory controller on the home node
- Tracks all lines cached in the system from the home node

Eliminates most probe broadcasts (see diagram)

- Lowers latency
 - local accesses get local DRAM latency, no need to wait for probe responses
 - less queuing delay due to lower HT traffic overhead
- Increases system bandwidth by reducing probe traffic







Where Do We Put the HT Assist Probe Filter?

- Q: Where do we store probe filter entries without adding a large on-chip probe filter RAM which is not used in a 1P desktop system?
- A: Steal 1MB of 6MB L3 cache per die in "Magny-Cours"



Implementation in fast SRAM (L3) minimizes

- Access latency

systems

- Port occupancy of read-modify-write operations
- Indirection latency for cache-to-cache transfers





Format of a Probe Filter Entry

- 16 probe filter entries per L3 cache line (64B), 4B per entry, 4-way set associative
- 1MB of a 6MB L3 cache per die holds 256k probe filter entries and covers 16MB of cache





Cache Coherence Protocol

- Track lines in M, E, O or S state in probe filter
- PF is fully inclusive of all cached data in system
 if a line is cached, then a PF entry must exist.
- Presence of probe filter entry says line in M, E, O or S state
- Absence of probe filter entry says line is uncached
 - New messages
 - Directed probe on probe filter hit
 - Replacement notification E -> I (clean VicBlk)





Probe Filter Transaction Scenarios

	PF Hit					PF Miss (*)				
	I	0	S	S1	EM	I	0	S	S1	EM
FETCH	-	D	-	-	D	-	В	В	DI	DI
LOAD	-	D	-	-	D	-	В	В	DI	DI
STORE	-	В	В	В	DI	-	В	В	DI	DI



(*) PF miss implies line is Uncached (no broadcast necessary). State refers to the state of the line to be replaced upon allocation of new PF entry.

Traditional "Cache Hit Ratio" does not measure effectiveness of probe filter





Probe Filter Coverage Ratio





HT Assist and Memory Latency

With "old" broadcast coherence protocol, the latency of a memory access is the longer of 2 paths:

- time it takes to return data from DRAM and
- the time it takes to probe all caches

With HT Assist, <u>local memory latency</u> is significantly reduced as it is not necessary to probe caches on other nodes.

Several server workloads naturally have ~ 100% local accesses

- SPECint®, SPECfp®
- VMMARKTM typically run with 1 VM per core
- SPECpower_ssj® with 1 JVM per core
- STREAM

Probe Filter amplifies benefit of any NUMA optimizations in OS/ application which <u>make memory accesses local</u>

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A Look Ahead

Socket compatible upgrade to "Magny-Cours" is planned with

- More cores for additional thread-level paralleism
- More cache to maintain cache-per-core balance
- Same power envelope
- Finer grain power management

New processor core ("Bulldozer")

- Planned brand new x86 64-bit microarchitecture
- 32nm design
- Instruction set extensions
- Higher memory level parallelism





Thank you!





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